

Product Summary

V _{BR} (Min)	I _{PP} (Max)	C _T (Typ)
25.4V	5A	25pF

Description and Applications

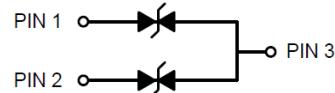
This DESD2FLEX2SOQ is a next generation ESD and surge protection device packaged in a small footprint surface mount package. It is qualified to AEC-Q101, supported by a PPAP and is designed to protect two automotive FlexRay bus lines from ElectroStatic Discharge and other transients.

- FlexRay Bus Protection
- Industrial Control Network

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Bottom View



Device Schematic

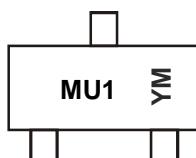
Ordering Information (Note 5)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DESD2FLEX2SOQ-7	Automotive	MU1	7	8	3,000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



MU1 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: D = 2016)
 M = Month (ex: 9 = September)

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020
Code	B	C	D	E	F	G	H
Month	Jan	Feb	Mar	Apr	May	Jun	Jul
Code	1	2	3	4	5	6	7

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_{PP}	230	W	8/20 μs , per Figure 1
Peak Pulse Current	I_{PP}	5	A	8/20 μs , per Figure 1
ESD Protection – Contact Discharge	$V_{ESD_Contact}$	± 30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	± 30	kV	IEC 61000-4-2 Standard

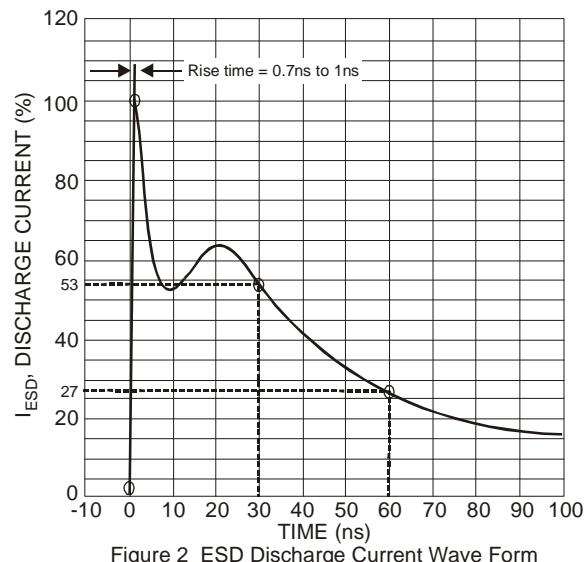
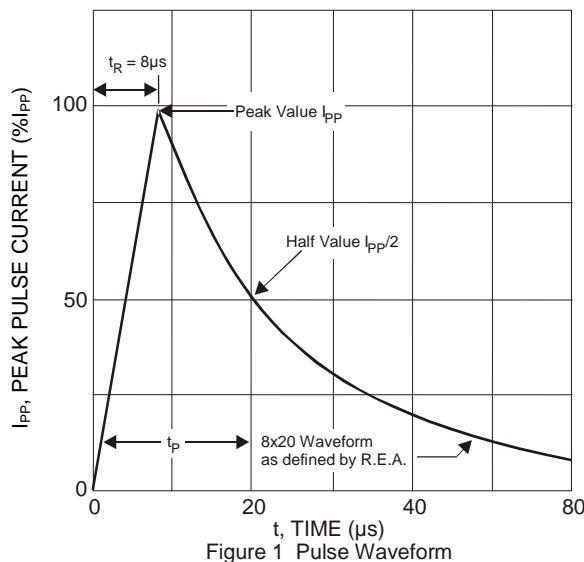
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	P_D	300	mW
Thermal Resistance, Junction to Ambient (Note 6)	R_{JJA}	417	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	—	—	24	V	—
Channel Leakage Current (Note 7)	I_{RM}	—	<1	10	nA	$V_{RWM} = 24\text{V}$
Clamping Voltage, Positive Transients	V_{CL}	—	—	34	V	$I_{PP} = 1\text{A}$, $t_p = 8/20\mu\text{s}$, Figure 1
		—	—	41	V	$I_{PP} = 5\text{A}$, $t_p = 8/20\mu\text{s}$, Figure 1
Breakdown Voltage	V_{BR}	25.4	28.0	30.3	V	$I_R = 1\text{mA}$
Differential Resistance	R_{DIF}	—	0.4	—	Ω	$I_R = 1\text{A}$, $t_p = 8/20\mu\text{s}$
Channel Input Capacitance	C_T	—	25	30	pF	$V_R = 0\text{V}$, $f = 5\text{MHz}$

Notes: 6. Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 7. Short duration pulse test used to minimize self-heating effect.



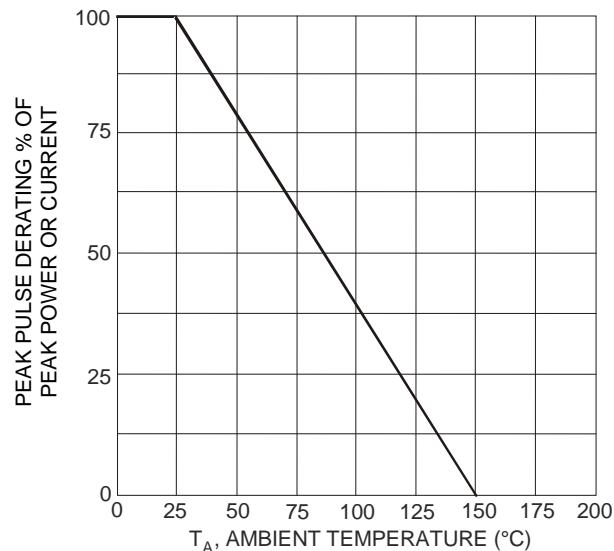


Figure 3 Power Dissipation vs. Ambient Temperature

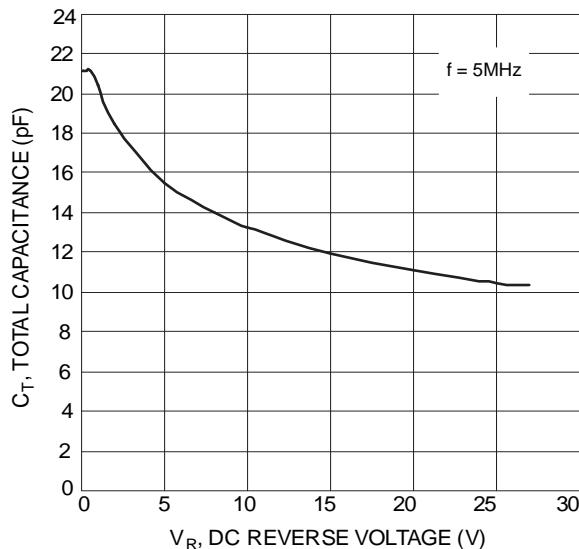


Figure 4 Total Capacitance vs. Reverse Voltage

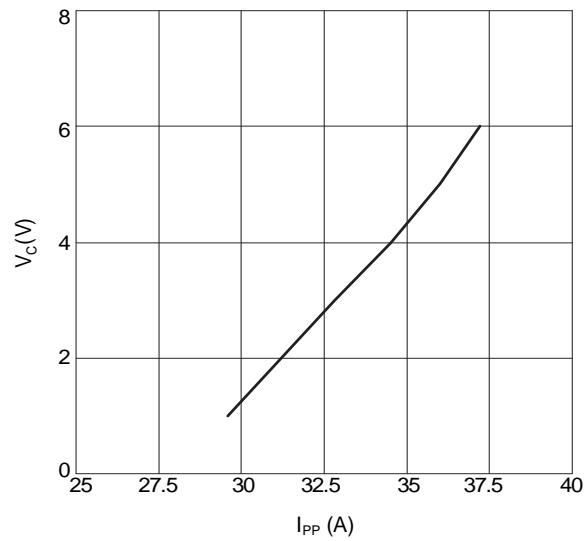


Figure 5 Typical Peak Clamping Voltage
V_C vs. Peak Pulse Current I_{PP}

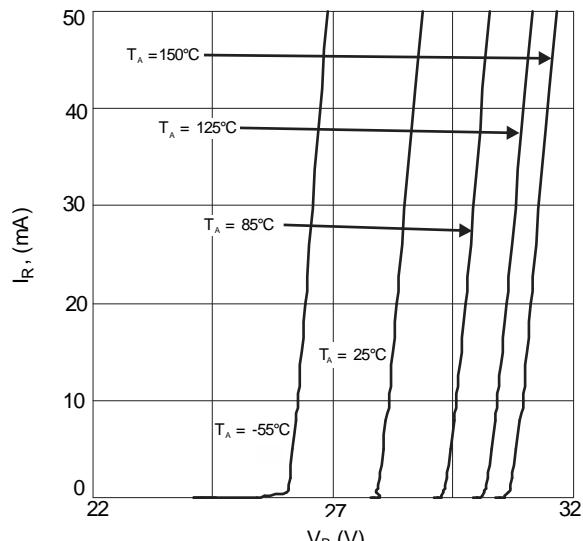
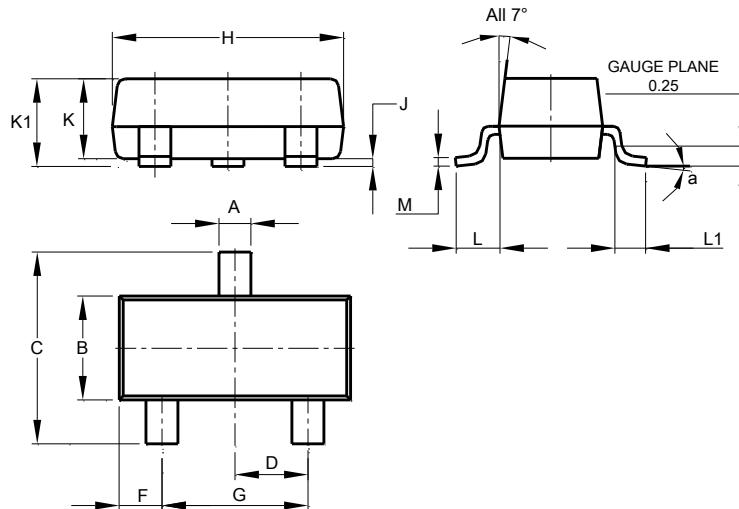


Figure 6 Reverse Current
as a Function of Reverse Voltage

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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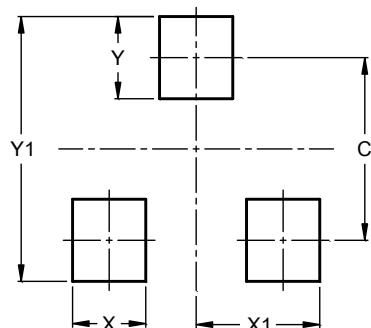
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Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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